

Cornell University



Strain Engineering Valleytronics for State Coherence

Exploring novel quantum degrees of freedom for next-generation computation!

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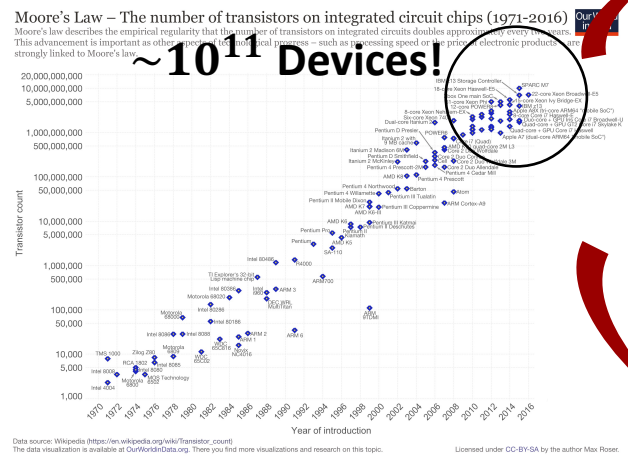
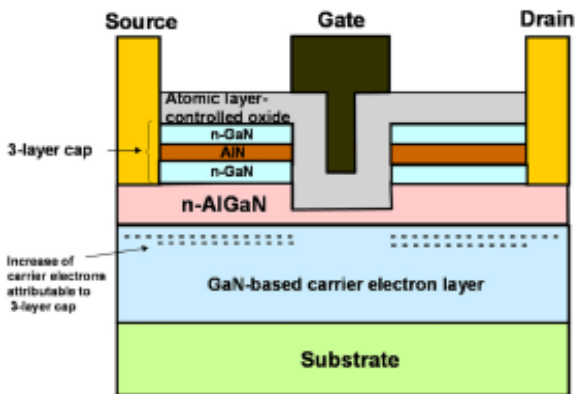
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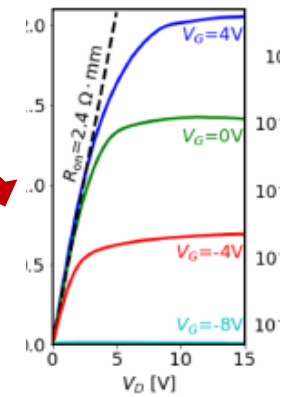
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Coming to the End of Moore's Law?

- IC transistor density scales linear with time
- Power loss scaling quadratic
- Major effort to reduced subthreshold voltage swing \rightarrow 60 mV/Dec



Low V_S



Heat Loss



III-V CMOS Design Concepts Dominant (HEMT) [Cornell Group Proposal]

Let's forget voltage? Think light. Think valleys.

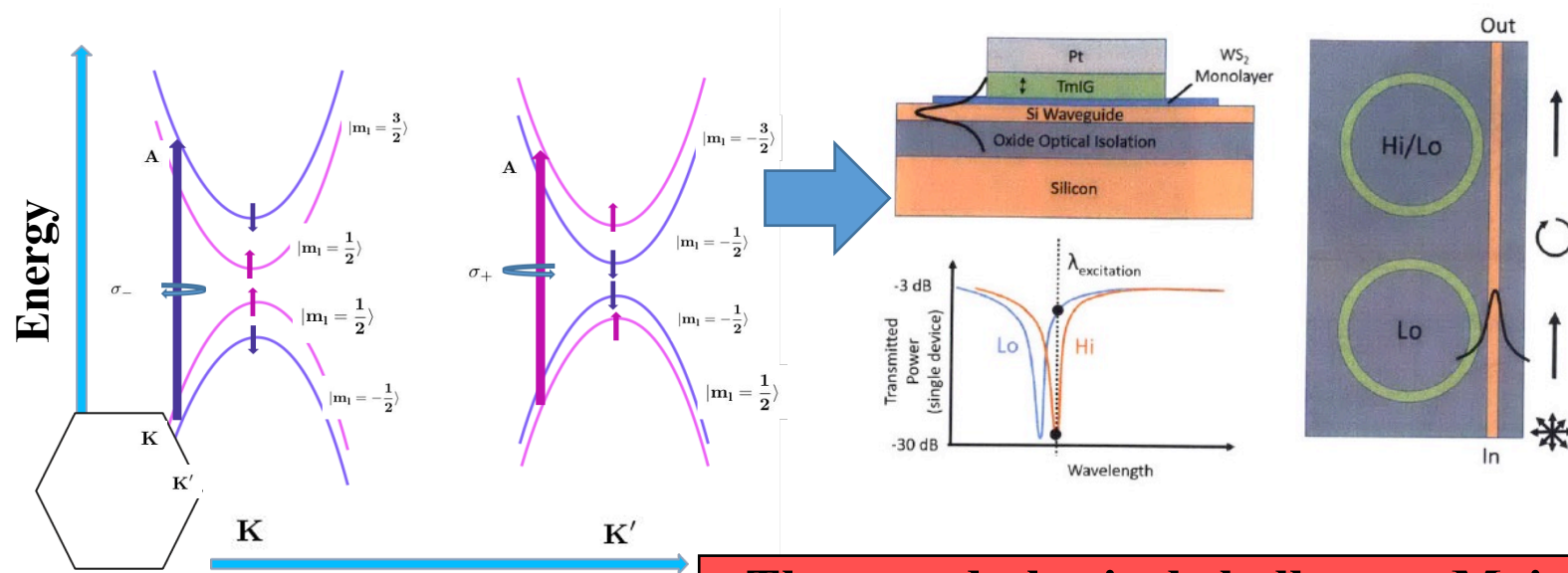


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Valleytronics: Moving Electrons with Light for Computation

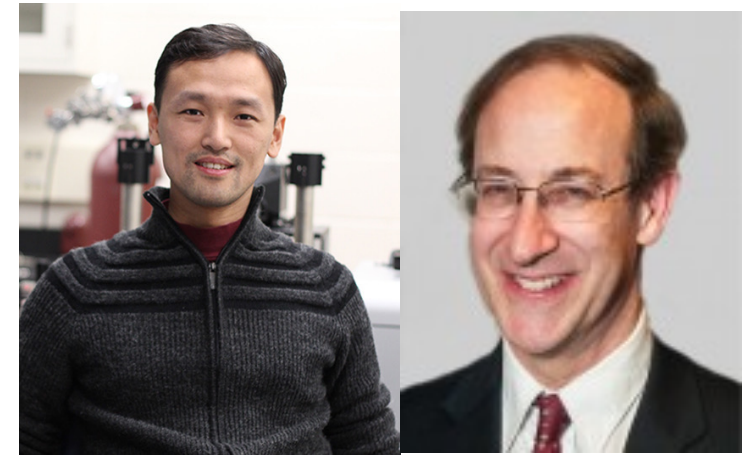
Time-reversal symmetry \rightarrow Valley index corresponding to K/K' points in momentum space couple to right and left polarized light \rightarrow NO GATE VOLTAGE = NO HEATING



Control of valley polarization in monolayer MoS₂ by optical helicity

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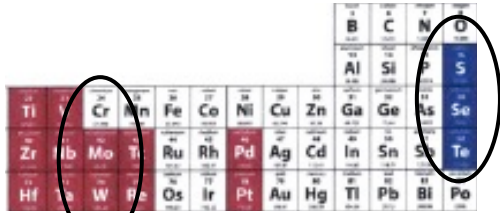


Kin Fai Mak
(Cornell)

Tony Heinz
(Columbia)

The grand physical challenge: Maintain state coherence to be robust to lattice vibrations. So heat doesn't matter?

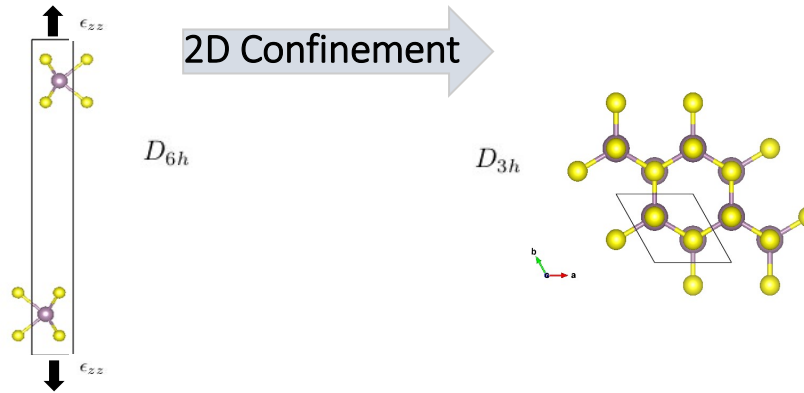
A Brief Introduction to 2D Transition Metal Dichalcogenides



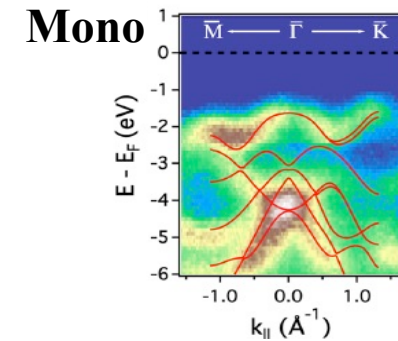
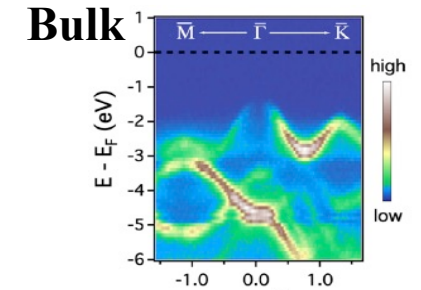
TMDs
 Mo/W + S/Se
 -Earth abundant
 -Used in lubricants



2D Confinement of MoS₂ with Uniaxial Strain Direct Band Gap Transition

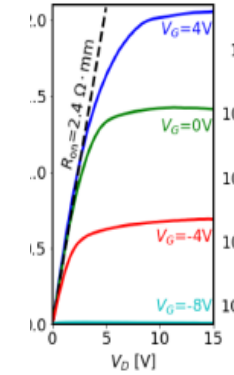
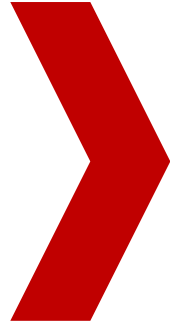
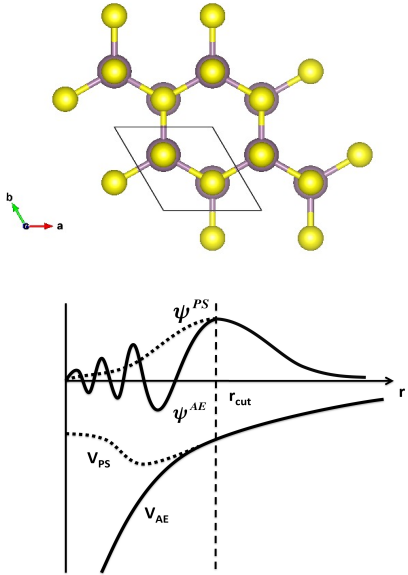


Break Inversion Symmetry



ARPES MoS₂
[Cornell]

Engineering Electronic Materials with Quantum Mechanics



$$(H_{KS}(\mathbf{k}) - \epsilon_n(\mathbf{k}))|\phi_{n,\mathbf{k}}^{KS}\rangle = 0$$

$$\frac{1}{\tau_{n\mathbf{k}}} = \frac{2\pi}{\hbar} \sum_{m\nu} \int \frac{d\mathbf{q}}{\Omega_{\text{BZ}}} |g_{nm\nu}(\mathbf{k}, \mathbf{q})|^2 \times [(1 - f_{m\mathbf{k}+\mathbf{q}} + n_{q\nu})\delta(\epsilon_{n\mathbf{k}} - \hbar\omega_{q\nu} - \epsilon_{m\mathbf{k}+\mathbf{q}}) + (f_{m\mathbf{k}+\mathbf{q}} + n_{q\nu})\delta(\epsilon_{n\mathbf{k}} + \hbar\omega_{q\nu} - \epsilon_{m\mathbf{k}+\mathbf{q}})].$$

Hypothesize/tune structure and pseudo-interactions

Solve SE for material in super computer → use DFT → obtain wavefunctions

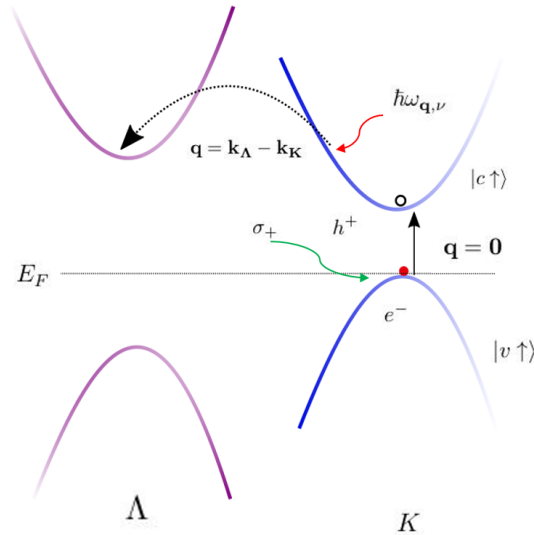
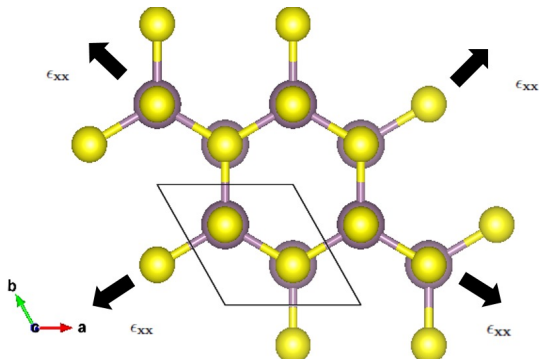
Predict electronic properties → device behavior, carrier lifetimes

Engineering Coherence by Stretching Atomic Layers

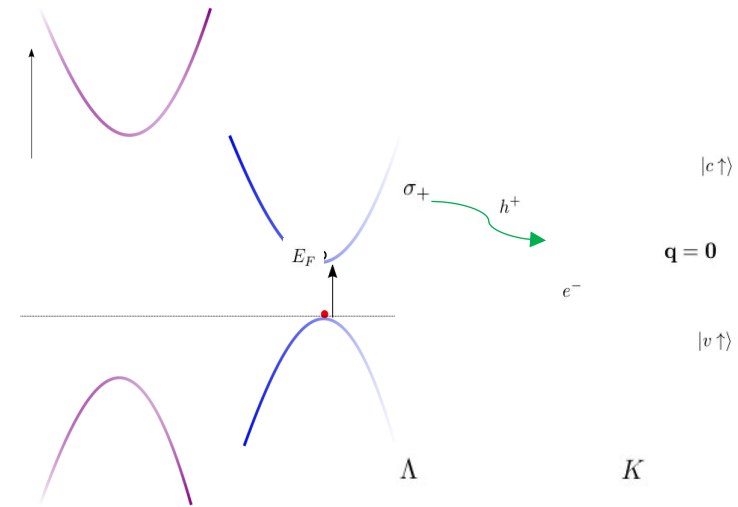
Proposal= Apply biaxial strain to 2D TMD material

-Spatially separate K- Λ valleys \implies fewer intervalley scattering events \rightarrow thermal vibrations don't interfere coherence \rightarrow longer exciton lifetime

-Energetically separate K- Λ valleys \rightarrow only desire direct transitions for valley logic coherence



$$\epsilon_{xx} = 0$$

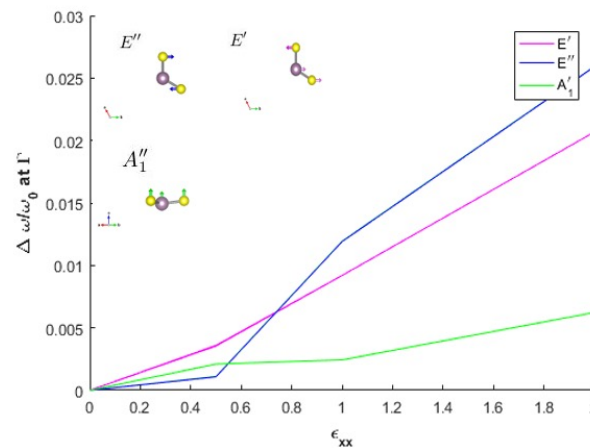
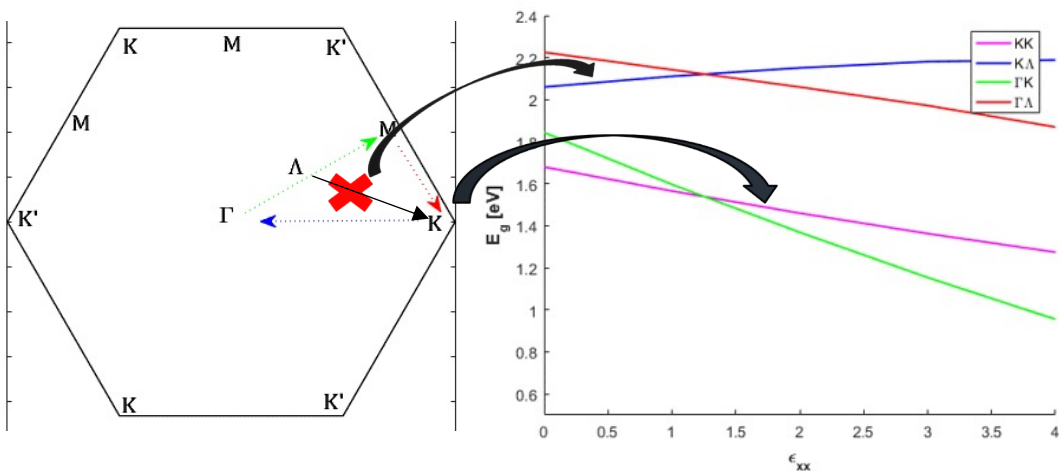


$$1.0\% < \epsilon_{xx} < 2.0\%$$

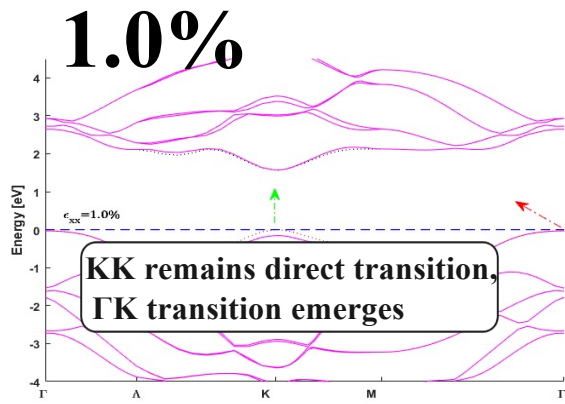
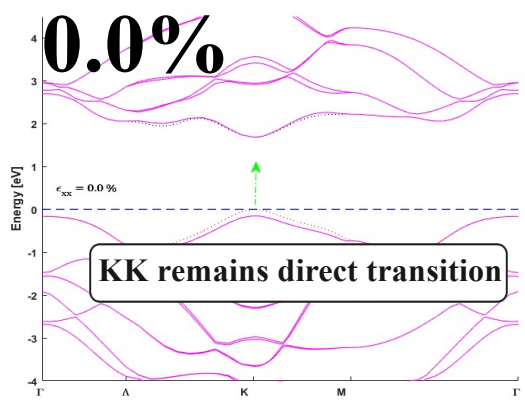
Theoretical Results of Strain Engineering Valleytronics

Energetics → energetic contribution to coherence improves with strain

K-space transition → energetic contribution to coherence improves with strain



Upper bound on strain
= 1.0 % → stay between 0-1.0%



Take away → we can now engineer valley coherence of devices with application of biaxial strain on 2D materials



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So just ask the right questions and think valleys...

